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	DESIGNATED/ELECTED OFFICE (DO/EO/US)	U.S. APPLICATION NO. (If known, see 37 CFR 1.5
	CONCERNING A FILING UNDER 35 U.S.C. 371	10/030027
INTER	NATIONAL APPLICATION NO. INTERNATIONAL FILING DATE	PRIORITY DATE CLAIMED
	C/CA00/00807 07/07/2000	07/07/1999
	OF INVENTION APOUR MANAGEMENT SYSTEM	
D	CANT(S) FOR DO/EO/US ennis William Mount	
Applic	ant herewith submits to the United States Designated/Elected Office (DO/EO/US)	the following items and other information:
1.	This is a FIRST submission of items concerning a filing under 35 U.S.C. 371.	•
2.	This is a SECOND or SUBSEQUENT submission of items concerning a filing u	nder 35 U.S.C. 371.
3. <b>X</b>	This is an express request to begin national examination procedures (35 U.S.C. 3' items (5), (6), (9) and (21) indicated below.	71(f)). The submission must include
4. X	The US has been elected by the expiration of 19 months from the priority date (A	rticle 31).
5. X	A copy of the International Application as filed (35 U.S.C. 371(c)(2))  a. X is attached hereto (required only if not communicated by the Internation	nal Rureau)
	b. has been communicated by the International Bureau.	iai Buicau).
	c. is not required, as the application was filed in the United States Receiving	ng Office (RO/US).
6.	An English language translation of the International Application as filed (35 U.S.	C. 371(c)(2)).
•	a. is attached hereto. International Application is in	English
	b. has been previously submitted under 35 U.S.C. 154(d)(4).	
7. 🛮	Amendments to the claims of the International Aplication under PCT Article 19 (	
	a. X are attached hereto (required only if not communicated by the International Paragraphy of	onal Bureau).
	b. have been communicated by the International Bureau.	ente has NOT expired
	c. have not been made; however, the time limit for making such amendme	into has 1401 expired.
۰. 🗆	<ul> <li>d.  have not been made and will not be made.</li> <li>An English language translation of the amendments to the claims under PCT Article.</li> </ul>	cle 19 (35 H S C 371 (c)(3))
8. <b></b> 9. <b>X</b>	An oath or declaration of the inventor(s) (35 U.S.C. 371(c)(4)).	010 15 (35 0.15.0. 571 (0)(0)).
	An English lanugage translation of the annexes of the International Preliminary E	vamination Report under PCT
10.	Article 36 (35 U.S.C. 371(c)(5)).	Adminiation respect and of 1 0 1
Iten	as 11 to 20 below concern document(s) or information included:	
11.	An Information Disclosure Statement under 37 CFR 1.97 and 1.98.	
12. 🔀	An assignment document for recording. A separate cover sheet in compliance v	with 37 CFR 3.28 and 3.31 is included.
13.	A FIRST preliminary amendment.	
14.	A SECOND or SUBSEQUENT preliminary amendment.	
15.	A substitute specification.	
16.	A change of power of attorney and/or address letter.	
17.	A computer-readable form of the sequence listing in accordance with PCT Rule	13ter.2 and 35 U.S.C. 1.821 - 1.825.
18.	A second copy of the published international application under 35 U.S.C. 154(d	)(4).
19. 🗌	A second copy of the English language translation of the international application	on under 35 U.S.C. 154(d)(4).
20.	Other items or information:	
	Power of Attorney	
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21. The follow	ving fees are submitted:		CAL	CULATIONS	PTO USE ONLY			
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Total claims	- 20 =		x \$18.00	\$				
Independent claims	-3 =		x \$84.00	\$				
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c. The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No A duplicate copy of this sheet is enclosed.								
d. Fees are to be charged to a credit card. WARNING: Information on this form may become public. Credit card information should not be included on this form. Provide credit card information and authorization on PTO-2038.								
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#### BACKGROUND OF THE INVENTION

Volatile solvents are used in many industrial processes in which the volatile solvent is used for cleaning purposes. As a result of such use the volatile solvent becomes contaminated with foreign matter. Due to the cost of such volatile solvents, environmental concerns, and the cost of disposing of such contaminated volatile solvents, it is desirable to maximize the use that can be made of the volatile solvent by removing the contamination from it by recycling it into the purified solvent form for further use in the industrial process.

In addition to industrial processes requiring purification and recovery of volatile solvents, there are also many industrial processes in which it is important to control the escape of vapour from volatile liquids. The escape of vapour from such volatile liquids represents an environmental and occupational health concern, and a financial cost in that the vapour is lost. The current procedure for preventing or reducing vapour loss is to provide a scrubbing system on tanks, containers or stacks in which the volatile liquid, or the vapour is stored. While the scrubbing system may reduce or even eliminate the environmental concerns of vapour loss, it does not overcome the cost of the loss of such vapour. Further, the used scrubbing material may in itself present an environmental disposal problem. Examples of such containers include oil storage tanks and gasometers. Other examples include the containment of vapours from stacks or from recycled solvents in processes such as gun-washing in automotive paint shops.

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Currently the common practice for purifying and recovering contaminated volatile solvents is distillation and condensation. Typically the solvent is boiled such that a vapour is formed. The vapour is then allowed to pass through a spiral or serpentine tube where it is cooled by heat exchange with air blown across the tube or with another liquid which flows around the outside of the tube. The heat exchange leads to condensation into the liquid phase inside the tube. This liquid phase then runs off into an open collection vessel. This method has a disadvantage in that as the vapour condenses in the tube, it has the potential for the build-up of back pressure within the distillation vessel which gives rise to a "champagne effect", i.e. vigorous boiling and cavitation, rather than controlled evaporation. This has the consequence of a potential safety hazard, reduced efficiency, and increased operating costs.

Further, the run off into an open collection vessel used in conventional systems leads to a loss of volatile solvent to the environment. This loss of solvent from an open collection vessel to the environment reduces the recovery of the solvent and causes an environmental hazard for operators around such tanks.

A further problem with conventional processes is the presence of uncondensed vapour in the collection vessel. Further, sealing the collection vessel, or the connection to the collection vessel from the distillation vessel in conventional systems causes pressure buildup unless vented. Such a pressure buildup or back pressure caused by uncondensed vapour in the collection vessel, or the conduit leading thereto can result in "foaming" in the distillation vessel. In order to prevent buildup of back pressure in the collection vessel and

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consequently the distillation vessel, the collection vessel must be vented. Similarly, any vessel in which, or into which, a volatile solvent is placed requires a vent in order to avoid vapour lock. Conventional methods of venting lead to loss of volatile solvent in the form of vapour into the atmosphere, thereby further reducing the efficiency of conventional methods of distillation and condensation and creating an environmental hazard.

Hence, there is a need for a method of condensing a volatile vapour which will ideally prevent any significant loss of volatile solvent from the system, and enhance recovery and condensation of the vapour to liquid. The consequence of this increased recovery of volatile vapour is a decrease in the overall cost of the vapour recovery, improved safety of the system, and a reduction in potential environmental harm.

#### SUMMARY OF THE INVENTION

Accordingly, the present invention provides a vapour recovery system for efficient and safe recovery of a vapour from a solvent comprising:

a distillation module comprising a distillation chamber for the solvent and heating means for heating the chamber to vaporize the solvent;

a direct condensation module comprising a container for condensing the vapour and collecting the solvent in the liquid phase;

conduit means for directing the vapour substantially without condensation from the distillation chamber to the direct condensation module, the conduit means sloping downwardly towards the distillation chamber to allow any condensate formed within the conduit to drain into the distillation chamber;

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a vapour management module for condensing vapour remaining uncondensed by the direct condensation module; and

a vapour outlet located above the surface of the liquid in the direct condensation module, the vapour outlet communicating with the vapour management module to allow for passage of vapour from the direct condensation module to the vapour management module.

In a further aspect of the invention, a vapour management system comprises a container containing heat absorbing material, a vent, a vapour inlet and means for guiding vapour from the vapour inlet through the heat absorbing material to the vent. The vapour may be guided through the container by means of a conduit extending between the vapour inlet and the vent, the conduit passing through the heat absorbing material. Alternatively, the container may contain solid heat absorbing material which is permeable to vapour and condensation and through which the vapour passes from the vapour inlet to the vent.

### BRIEF DESCRIPTION OF THE DRAWINGS

Figure 1 is a schematic view of a preferred embodiment of the vapour recovery system comprising a distillation unit, a direct condensation module and a vapour management module.

Figure 2 is a sectional view of a preferred embodiment of the distillation unit of the vapour recovery system illustrated in Figure 1.

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Figure 3 is a sectional view of a preferred embodiment of the distillation unit of the vapour recovery system illustrated in Figure 1, in which the heating means is located at the upper end of the distillation chamber.

Figure 4 is a sectional view of a preferred embodiment of a lined distillation chamber of the vapour recovery system illustrated in Figure 1.

Figure 5 is a sectional view of a preferred embodiment of the direct condensation module of the vapour recovery system illustrated in Figure 1.

Figure 6 is a sectional view of a preferred embodiment of the vapour management module of the vapour recovery system illustrated in Figure 1.

Figure 7 is a partial sectional view of an alternative embodiment of the vapour management module in which embodiment the heat absorbing material is in a solid form.

Figure 8 is a schematic representation of a heating control system that is employed in the distillation module to control the rate of vaporization of solvents.

### DETAILED DESCRIPTION OF PREFERRED EMBODIMENTS

The preferred embodiment of a vapour recovery system for solvents according with the invention is shown in Figure 1. In this embodiment the vapour recovery system [10] comprises a distillation module [1], a direct condensation module [11] and a vapour

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management module [31]. In this embodiment of the invention the solvent or mixture of solvents to be recovered is heated in the distillation module [1] to generate solvent vapour. This solvent vapour is then directed through a downwardly inclined conduit [12] to a vapour inlet [13] to the direct condensation module [11]. This downwardly inclined conduit [12] in a preferred embodiment of the invention extends within and toward the bottom of the condensation module [11]. There is substantially no condensation of the vapour in the conduit [12] but any condensate which does form runs down into the condensation module [11] and, therefore, no back-pressure is created by the condensate formation. The condensation module [11] is charged with a coolant liquid [14] which is the same solvent as that being distilled. Thus, as will be described in more detail hereinafter, in the condensation module [11], the vapour is subjected to a first round of cooling in which the heat absorbing material is the solvent to be recovered in the liquid phase [14]. Some vapour may pass through and exit from this liquid [14]. This vapour, plus air, then passes from the condensation module [11] through the vapour outlet [32] into the vapour management module [31]. In the vapour management module [31] the vapour air mixture is required to pass through a heat-absorbing material [44] and this heat exchange process leads to further condensation of vapour from the mixture. The remaining gases then leave the vapour management module [31] through a vent [42] and are substantially free of any solvent vapour. Preferably, any condensate formed in the vapour management module [31] runs back into the condensation module [11]. However the condensate formed in the vapour management module [31] can also be run into a secondary container, if desired.

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In a preferred embodiment illustrated in Figure 2, the distillation module [1] comprises a distillation chamber [2] in which the contaminated solvent or solvent mixture [S] to be recovered is collected. The distillation chamber [2] is closed to prevent the escape of any vapour generated therein other than through the conduit [12]. The size of the conduit [12] and the opening of the vapour inlet [13] to the direct condensation module [11] should be adequate to allow free passage of vapour from the distillation chamber [2] without resulting in a pressure build up in the distillation chamber [2]. Further, the conduit [12] is ideally positioned toward the upper end of the distillation chamber [2] since the hot vapour will rise. This distillation chamber [2] sits within a larger heating vessel [3] containing an oil bath [5]. The heating vessel [3] is provided with one or more heating elements [4] immersed in the oil and, in operation, each heating element [4] heats the oil [5], which in turn heats the distillation chamber [2] at least until the solvent [S] within the distillation chamber reaches its boiling point and vapour is generated. Once the boiling point of the solvent is reached, the power supplied to the heating element is controlled to regulate the rate of vaporization of the solvent until the solvent is substantially all evaporated.

It is essential that the oil [5] have a boiling point higher than that of the solvent to be recovered or, in the case of a solvent mixture, the boiling point of the highest boiling component of the mixture. In addition, the oil [5] should not be flammable within the temperature ranges in which the distillation module [1] will operate. In the preferred embodiment, the oil [5] in the heating vessel [3] will surround a substantial portion of the distillation chamber [2] (for example, to the level 5a in Figure 2) to ensure that there is

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sufficient heat to maintain the evaporated solvent in the vapour phase at least as far as the conduit [12].

While the preferred embodiment describes the means for heating the distillation chamber [2] as comprising a heating vessel [3] containing one or more heating elements [4] immersed in oil [5], alternative means of heating the distillation chamber [2] are possible. In one alternative embodiment, the means for heating the distillation chamber [2] is an infrared lamp [L] located toward the upper end of the distillation chamber [2] as illustrated in Figure 3. The heating provided by such a lamp can be regulated by rheostatic control of the intensity of the lamp. In this embodiment of the invention, the solvent [S] in the distillation chamber [2] is heated from the top down. This top heating provides the advantage that only the top layer of the liquid to be distilled needs to be heated to initiate distillation. Further, as the distillation progresses, it is only the energy of vaporization for the top layer of the liquid that needs to be provided to continue the distillation.

The distillation chamber [2] is preferably provided with an anti-vacuum valve [V] (Figure 2) which prevents vapour from escaping from the distillation chamber [2], but is triggered to allow entry of outside air when the pressure within the distillation chamber [2] falls below atmospheric. As the distillation chamber [2] cools down following distillation, the pressure in the distillation chamber [2] falls. Since the conduit [12] provides a passage from the distillation chamber [2] to the vapour inlet [13] which communicates with the liquid condensed in the condensation module [11], without the anti-vacuum valve [V] in the distillation chamber [2], the reduction in pressure would lead to a back-flow situation

with condensed solvent being drawn from the condensation module [11] into the conduit [12] through the vapour inlet [13], and thence into the distillation chamber [2].

In an alternative embodiment of the distillation module [1] there is a line feeding contaminated solvent directly into the distillation module [1] through source inlet [7]. In this embodiment, a means for preventing flow-back from the condensation module [11] to the distillation chamber [2] is provided. In addition, the anti-vacuum valve can be shut off such that any negative pressure created in the distillation chamber [2] as it cools can be used to draw more contaminated solvent for recycling into the distillation chamber [2] through source inlet [7]. This acts as a natural pump which can be used as part of the process since it allows continuous flow, without the need for separate pumps.

One aspect of the current invention is a heating control system, as illustrated schematically in Figure 8, that is employed in the distillation module to control the rate of vaporization of the solvent or solvents. In the distillation module, the solvents are separated from the impurities in the solution and may also be separated from each other. The control system is designed to do this in a time efficient manner while also minimizing operator intervention.

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The heating control system has three key components, a variable heating means [61], for example, a plurality of the heating elements [4] of Figure 2, a temperature sensing means [62], for example, a temperature probe [6] (see Figure 2) which may be either a platinum thermistor or a thermocouple, and a control computer [63], for example, a

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microprocessor with required software. The control computer [63], by use of a control law, selectively triggers relays [64] which are in series between a power supply and heating means [61] and which energize the heating means [61] in an ordered manner, in response to temperature reference signals input to the control computer [63] from the temperature sensing means [62]. In a preferred embodiment, which is especially useful where a mixture of solvents is to be distilled, an important element of this control system is a control law that allows the system to operate in 2 modes. The first mode is a solvent mode where the system begins to heat the mixture of solvents until the boiling point of the solvent with the lowest boiling point is reached. At the temperature of that lowest boiling point the power delivered to the heating means is maintained at a constant level to provide the energy of vaporization at a desired rate, until the first solvent has been substantially distilled from the solution. Once the first solvent has substantially distilled, the power provided to the system is no longer used to provide the required energy of vaporization and no further heat is being lost as a result of heated vapor, and therefore the temperature of the liquid in the distillation chamber [2] begins to rise. The power provided to the heating means can again be increased until the boiling point of the next solvent is reached. This control cycle is repeated until the solvents have all been vaporized.

The second mode is the water mode. In the water mode of the control system there is no advantage to stepped regulation of the temperature. Water has a relatively high specific heat capacity and requires significant energy input in order to boil. Therefore, in the water mode, it is not necessary to regulate the temperature as closely. In other words, in the water mode the distillation chamber and its contents can be heated continuously until the

evaporation is complete, at which time a timed heating cycle can then be brought into effect. The two modes of the control system allow the distillation chamber to be used for vaporization of water and organic solvents. Distillation can take place with a mixture of water and organic solvents, or either alone, with no significant foaming.

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The power applied to the heating means [61] during the vaporization phase for any particular solvent provides the energy of vaporization for that solvent. Therefore, controlling the power applied to the heating means [61] also controls the rate of vaporization, and is used to maintain an equilibrium with the condensation rate of the vapour in the system.

In the embodiment shown in Figure 2, the temperature sensing means is a probe [6] that is used to monitor the temperature of the distillation chamber [2]. The probe [6] detects an increase in temperature of the distillation chamber [2] as the solvent is heated. The rate of evaporation of solvent from the distillation chamber [2] is regulated by means of the control system of Figure 8.

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Controlling the rate of vaporization of the solvent in the distillation chamber [2] means that the vapour pressure in the distillation chamber [2] is closely regulated. Since the pressure differential between the distillation module [1] and the condensation module [11] is important, this strict regulation of vapour pressure will enhance the efficiency of vapour recovery. In addition, by closely regulating the rate of vaporization of the solvent,

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it is possible to reduce the required mass for solvent condensation in the condensation module [11].

After the liquid in the distillation chamber [2] has evaporated, a timed heating cycle is brought into effect by means of a timer system (not shown) which maintains the temperature in the distillation chamber [2] for a predetermined period of time. This post-evaporation heating ensures that essentially all of the solvent to be recovered is distilled. Further, the continued heating drives off any residual solvents and bakes any contaminants in the distillation chamber [2] so that the resulting solids can be disposed of more conveniently at a lower cost and with reduced environmental problems as compared to unbaked contaminants. In the embodiment of the invention as illustrated in Figure 4, the distillation chamber [2] is lined with a bag [8] such that, following baking, the entire bag [8] containing the baked contaminants can be disposed of. The bag [8] is stable within the temperature range of the distillation chamber [2]. In addition, it is important that the bag [8] be inert with respect to the solvents to be distilled. It is clear that the bag [8] can be made of any material provided it is heat stable, does not react with the solvents to be distilled, and is non-permeable, such as Teflon (trade-mark for polytetrafluoroethylene).

As can more clearly be seen by reference to the preferred embodiment illustrated in Figure 5, the condensation module [11] is comprised of a container [20] into which the vapour to be recovered enters via vapour inlet [13]. The condensation module is primed using a predetermined volume of the solvent to be recovered in the liquid phase [14]. This liquid [14] is free from contamination. The vapour entering the condensation module [11]

is directed by the inlet [13] to pass beneath the surface [15] of the liquid [14] such that the vapour bubbles through the liquid.

Ideally, the vapour entering the condensation module [11] is forced to the bottom of the container [20] by the inlet [13]. Some of the vapour will be cooled by the liquid [14] such that it condenses and combines with the liquid. As a result of such condensation the level of liquid in the container [20] will rise. The condensation may lead to an increase in the temperature of the liquid [14] if there is no external source for cooling the liquid. However, the corollary increase in the volume of liquid [14] in the container [20] means that the vapour which subsequently enters the container [20] must travel a greater distance through the liquid [14]. In addition, the coolest liquid will fall to the bottom of the container [20] where the vapour to be condensed is entering the condensation module [11].

Some vapour may pass through the liquid [14] and accumulate above the surface [15] in the upper volume [21] of the container [20]. The only way this accumulated vapour can escape from the container [20] is by passing through a vapour outlet [32] positioned above the upper volume [21]. The vapour, having entered the vapour outlet [32] from the condensation module [11], then passes from the outlet [32] into the vapour management module [31].

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In a preferred embodiment of the invention, as illustrated by Figure 6, the vapour management module [31] comprises a sealed chamber [45] containing a serpentine tube [43] communicating with the vapour outlet [32] at its entrance end and a vent [42] at its

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exit end. The mixture of air and solvent vapour exiting the condensation module [11] is directed via the outlet [32] through the tube [43], which is surrounded by a cooling medium [44] inside the sealed chamber [45]. The cooling medium [44] absorbs heat and therefore causes further condensation of the vapour so that substantially all of the vapour escaping from the condensation module [11] is condensed and prevented from reaching the atmosphere through vent [42]. The medium [44] can be any suitable coolant medium. Ideally, the medium [44] will provide sufficient heat absorption for condensation of all vapours, such that only air exits the system through vent [42].

In one preferred embodiment of the invention, the medium [44] is water mixed with a salt to form a crystallized mass which has a low expansion rate and can be contained safely in the sealed chamber [45]. The tube [43] allows condensed solvent to flow back by gravity through the outlet [32] into the condensation module [11], while allowing the remaining uncondensed vapour (which is a very small amount, if any) and air to exit the vapour management module [31] to the atmosphere through the vent [42]. The condensate can continue to flow counter to the air/vapour flow, through the outlet [32] and be collected in the container [20] of the condensation module [11], or in a separate container.

The container [20] may be provided with a tap [T], which can be used to drain the liquid [14]. Ideally, this tap is situated below the surface [15] of the liquid, and the closer to the base of the container [20], the more liquid [14] can easily be drained off. The advantage of this arrangement is that liquid [14] being collected can be accessed at any time

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without losing vapour from the system. Further, condensed liquid [14] can be removed from the container [20] without interruption of the condensation.

If desired, a downwardly sloping overflow pipe [D] may be provided in the container [20] at a predetermined overflow level. As the level [15] of liquid [14] rises to that overflow level, a fixed volume of liquid is maintained in the container [20]. Any liquid [14] in excess of that volume enters the overflow pipe and runs by gravity into a collection vessel. This provides an advantage in that a large volume of material can be used as the coolant.

In another embodiment of the vapour management module [31], as illustrated in Figure 7, the air/solvent vapour mixture is allowed to pass from the outlet [32] to the vent [42] without the use of a tube [43]. In this embodiment, the material [44] is a solid material for example, ball bearings or glass chips, through which the vapour and condensate are able to pass. The material may be prevented from falling back through the outlet [32] into the container [20] either by selecting the size of the material particles to be sufficiently large, or by the insertion of a support member [46] which is permeable to both the liquid [14] and the air/vapour mixture, but through which the material [44] cannot pass.

Maximizing the ratio of the heat exchange surface to the volume of vapour passing into the vapour management module [31] increases the efficiency of the condensation in the vapour management module [31].

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In accordance with the present invention, the vapour management module [31] can be designed such that essentially no vapour exits the vent [42]. This is achieved by ensuring that the rate of heat input does not exceed the rate of heat absorption in the vapour management module. It is clear that factors such as the rate of vapour flow, the vapour temperature, the heat absorption properties of the material and the path length through the vapour management module are important. In one embodiment of the invention, the heat absorbing material is a crystalline salt, the pipe [43] is of 12mm bore and 75 cm in length, made of heat conductive metal such as copper, and the heat input to the vapour management module in the form of vapour is 1500W.

In selecting the appropriate solid material [44] in the above embodiments, ideally the material should allow the vapour to flow through at approximately atmospheric pressure, provide the required absorption of heat, and allow the condensed liquid [14] to flow by gravity back to a reservoir.

Those skilled in the art will appreciate that various combinations of condensation modules [11] and vapour management modules [31] are possible. Further, it is possible to use either the condensation module or the vapour management module in isolation from the system, provided there is an input of vapour to such modules. It is possible to use the vapour management module [31] to recover vapour from any vent or exhaust. Examples of situations where the vapour management module [31] could be used are on a vent to an oil storage tank, a vent on a gasometer, or a vapour stack of a spray booth. In these situations, the vapour would arise as a consequence of evaporation of the liquid to be recovered.

Condensate formed in such vapour management modules can then run back by gravity into the vent and ultimately back to the container of the liquid to be recovered, or to another container. It is clear to those skilled in the art that in these situations the heat absorbing material must be cooler than the vapour to be recovered.

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Further, while the preferred embodiment utilizes both a condensation module [11] and a vapour management module [31] and has been found to have excellent results, each solvent to be recovered will have different requirements. It is certainly possible to subject the vapour to sequential steps of direct condensation and/or to sequential vapour management modules [31]. The efficiency of vapour recovery will determine the most suitable module arrangement.

It should be clear that while the preferred embodiments described above describe specific arrangements of heat absorbing material, variations are possible. For example, it is not essential to have any liquid in the condensation module [11] prior to initiation of condensation. Alternatively, any material that absorbs heat from the vapour but does not chemically react with it would be suitable to use within the condensation module, including a solid mass or air. A solid inert mass such as rocks or ball bearings are suitable to absorb heat in the condensation module [11]. Alternatively, air in the condensation module [11] can rapidly absorb heat from the vapour entering the condensation module [11] since heat exchange is rapid between gases. Any liquid [14] accumulating as a result of condensation in the condensation module [11] also acts to absorb heat from the vapour.

While only specific embodiments of the invention have been described, it is apparent that various additions and modifications can be made thereto, and various alternatives can be selected. It is, therefore, the intention in the appended claims to cover all such additions, modifications and alternatives as may fall within the true scope of the invention.



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THE EMBODIMENTS OF THE INVENTION IN WHICH AN EXCLUSIVE PROPERTY OR PRIVILEGE ARE CLAIMED ARE DEFINED AS FOLLOWS:

5 1. A solvent vapour recovery system comprising:

a distillation module comprising a distillation chamber for said solvent and heating means for heating said chamber to vaporize the solvent;

a direct condensation module comprising a container which holds a heat absorbing mass through which said vapour is passed for condensing the vapour and collecting the solvent in the liquid phase;

conduit means for directing the vapour substantially without condensation from said distillation chamber into said heat absorbing mass within said container;

a vapour management module for condensing vapour remaining uncondensed by said direct condensation module; and

a vapour outlet located above the surface of said heat absorbing mass in said container, said vapour outlet communicating with said vapour management module to allow for passage of vapour from the container to the vapour management module.

- The apparatus of claim 1 wherein said conduit means slope downwardly towards said
   heat absorbing mass to allow any condensate formed within said conduit to drain into said
   heat absorbing mass.
  - 3. The apparatus of claim 1 or claim 2, wherein the heat absorbing mass comprises a liquid.

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AMENDED SHEET



- 4. The apparatus of claim 1 or claim 2, wherein the heat absorbing mass comprises the vapour to be recovered in its liquid phase.
- 5. The apparatus of claim 1 or claim 2, wherein the heat absorbing mass comprises a combination of the vapour to be recovered in its liquid phase and a solid.
  - 6. The apparatus of claim 1 or claim 2, wherein the heat absorbing mass is air.
  - 7. The apparatus of claim 1 or claim 2, wherein the heat absorbing mass is a solid.
  - 8. The apparatus of any one of claims 3 5 wherein the conduit directs vapour beneath the surface of said mass.
- 9. The apparatus of any one of claims 1 8 wherein the conduit directs vapour to the bottom of said container.
- 10. The apparatus of any one of claims 1 9 wherein the distillation chamber is located within an oil bath which is heated by said heating means.
- 20 11. The apparatus of claim 10 wherein the heating means comprises one or more heating elements located within said oil bath.
  - 12. The apparatus of any one of claims 1 9 wherein the distillation chamber is heated by





means of an infrared heater located within said chamber.

- 13. The apparatus of claim 1 further comprising means for connecting said heating means to a power supply and a control means for controlling the power provided by said power supply to said heating means, said control means comprising a computer, sensing means for sensing a parameter which is dependent upon the rate of vaporization of solvent within said distillation chamber and generating reference signals which are provided as input signals to said computer and switching means for selectively providing power to said heating means from said power supply, said computer being programmed to apply control signals to said switching means to control the amount of power applied to said heating means in accordance with said input signals received from said sensing means.
- 14. The apparatus of claim 13, wherein said parameter is the temperature of said distillation chamber.
- 15. The apparatus of claim 13 or 14, wherein said computer is programmed with a set of parameters based on the input signals received from the sensing means which, if exceeded, will activate said switching means to perform an ordered shutdown of said heating means by selectively activating said switching means to disconnect said heating means from said power supply.
- 16. The apparatus of claim 14, wherein the temperature sensing means comprises one or more platinum thermistor temperature probes.

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AMENDED SHEET

- 17. The apparatus of any one of claims 13 16, wherein said heating means consists of at least one heating element.
- 18. The apparatus of any one of claims 13 16, wherein said heating means consists of a direct heating means.
- 19. The apparatus of claim 18, wherein said direct heating means consists of an infrared heating lamp.
- 20. The apparatus of any one of claims 13 19, wherein said switching means comprises one or more relays.
- 21. The apparatus of claim 13, wherein said heating means consists of a plurality of heating elements and said switching means comprises a plurality of relays respectively connecting said heating elements to said power supply.
- 22. The apparatus of any one of claims 13 21, wherein said computer is programmed with a control law so that when a mixture of solvents is to be distilled in said distillation chamber, said computer runs a distillation procedure wherein the heating means raises the solution to a temperature causing the solvent with the lowest boiling point to vaporize, the temperature is then maintained until the aforementioned solvent is substantially removed from the solution, at which time the temperature is allowed to rise until the solvent with the next lowest boiling point begins to vaporize and power is applied to said heating means to





maintain a desired rate of vaporization of said solvent, and the process is then repeated until all solvents have been distilled off.

- 23. The apparatus of claim 13, wherein said computer controls said switching means to vary the input to the heating means to balance the rate of vaporization of a solvent with the rate of condensation of the same solvent in a separate, but connected, container.
  - 24. The apparatus of claim 1, wherein said vapour management module comprises a heat absorbing mass and a conduit extending between an inlet to said vapour management module and a vent, said conduit passing through said heat absorbing mass.
  - 25. The apparatus of claim 24, wherein said vent is at a higher elevation than said vapour outlet of said direct condensation module.
- 15 26. The apparatus of claim 24 or 25, wherein the heat absorbing mass is a liquid.
  - 27. The apparatus of claim 24 or 25, wherein the heat absorbing mass is crystalline.
- 28. The apparatus of claim 24 or 25, wherein the heat absorbing mass is water mixed with a salt to form a crystallized state.
  - 29. The apparatus of claim 1, wherein said vapour management module comprises a solid heat absorbing mass which is permeable to vapour and condensation through which said





vapour passes from said direct condensation module to said vent.

- 30. The apparatus of claim 29, wherein the heat absorbing mass is steel ball bearings.
- 5 31. The apparatus of claim 29, wherein the heat absorbing mass is glass chips.
  - 32. The apparatus of any one of claims 29 31, wherein a support member for said heat absorbing mass is provided in said vapour outlet of said direct condensation module, said support member being permeable to vapour and condensation and impermeable to said heat absorbing mass.
  - 33. The apparatus of any one of claims 1 32, wherein the container of said direct condensation module is provided with a drainage means for draining liquid therefrom.
- 15 34. The apparatus of claim 33, wherein the drainage means comprises a tap.
  - 35. The apparatus of claim 33, wherein the drainage means comprises an overflow pipe in said container.
- 20 36. A vapour management system comprising a vapour inlet and a vapour outlet and means for passing vapour from said vapour inlet through a static heat absorbing mass to said vapour outlet, said heat absorbing mass being permeable to vapour and condensate passing through said mass and either being non-adsorbent of said condensate or being





comprised of the same liquid as said condensate.

- 37. A vapour management system comprising a static heat absorbing mass, a vapour outlet, a vapour inlet and a conduit passing through said heat absorbing mass in heat exchange therewith and extending between said vapour inlet and said vapour outlet for guiding vapour from said vapour inlet through said conduit to said vapour outlet.
- 38. The apparatus of claim 36 or 37, wherein said mass comprises a mixture of water and salt.
- 39. The apparatus of claim 36 or 37, wherein the heat absorbing mass is steel ball bearings.
- 40. The apparatus of claim 36 or 37, wherein the heat absorbing mass is glass chips.
- 41. The apparatus of claim 36 or 37, wherein the heat absorbing mass is air.
- 42. The apparatus of claim 36 or 37, wherein the heat absorbing mass is a solid mass.
- 20 43. The apparatus of claim 36 wherein the heat absorbing mass comprises a combination of the vapour to be recovered in its liquid phase and a solid mass.
  - 44. The apparatus of claim 43 wherein a support member for said solid mass is provided

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in said vapour inlet, said support member being permeable to vapour and condensate and impermeable to said solid mass.

- 45. Apparatus for connecting heating means for a distillation chamber in a solvent vapour recovery system to a power supply and a control means for controlling the power provided by said power supply to said heating means, said control means comprising a computer, sensing means for sensing a parameter which is dependent upon the rate of vaporization of solvent within said distillation chamber and generating reference signals which are provided as input signals to said computer and switching means for selectively providing power to said heating means from said power supply, said computer being programmed to apply control signals to said switching means to control the amount of power applied to said heating means in accordance with said input signals received from said sensing means.
  - 46. The apparatus of claim 45, wherein said parameter is the temperature of said distillation chamber.
  - 47. The apparatus of claim 45 or 46, wherein said computer is programmed with a set of parameters based on the input signals received from the temperature sensing means which, if exceeded, will activate said switching means to perform an ordered shutdown of said heating means by selectively activating said switching means to disconnect said heating means from said power supply.
  - 48. The apparatus of claim 46, wherein the sensing means comprises one or more





platinum thermistor temperature probes.

49. The apparatus of any one of claims 45 - 48, wherein said heating means consists of at least one heating element.

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- 50. The apparatus of claim any one of claims 45 48, wherein said heating means consists of a direct heating means.
- 51. The apparatus of claim 50, wherein said direct heating means consists of an infrared heating lamp.
  - 52. The apparatus of claim any one of claims 45 51, wherein said switching means comprises one or more relays.
- 15 53. The apparatus of claim 45, wherein said heating means consists of a plurality of heating elements and said switching means comprises a plurality of relays respectively connecting said heating elements to said power supply.
- 54. The apparatus of any one of claims 45 53, wherein said computer is programmed
  with a control law so that when a mixture of solvents is to be distilled in said distillation
  chamber, said computer runs a distillation procedure wherein the heating means raises the
  solution to a temperature causing the solvent with the lowest boiling point to vaporize, the
  temperature is then maintained until the aforementioned solvent is substantially removed

from the solution, at which time the temperature is allowed to rise until the solvent with the next lowest boiling point begins to vaporize and power is applied to said heating means to maintain a desired rate of vaporization of said solvent and the process is then repeated until all solvents have been distilled off.

55. The apparatus of claim 45, wherein said computer controls said switching means to vary the input to the heating means to balance the rate of vaporization of a solvent with the rate of condensation of the same solvent in a separate, but connected, container.

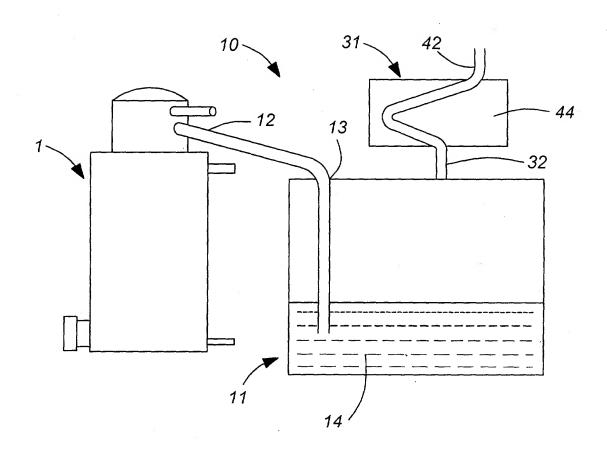


FIG. 1

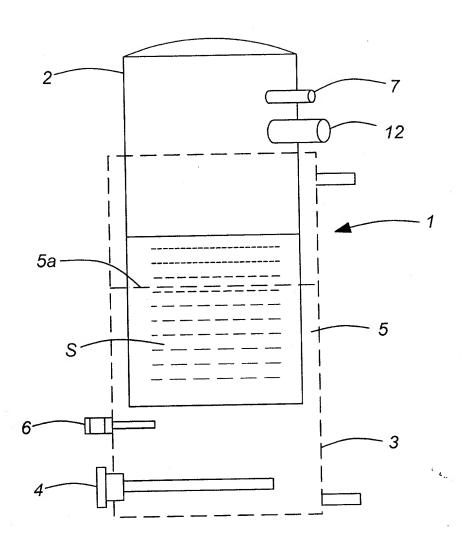
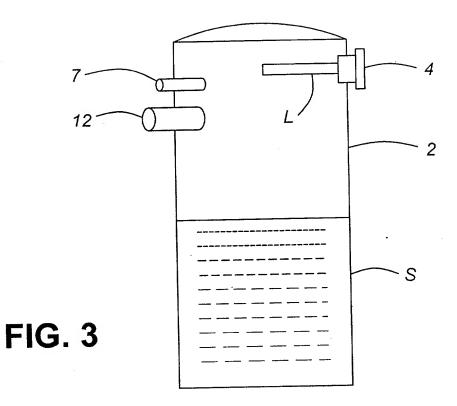
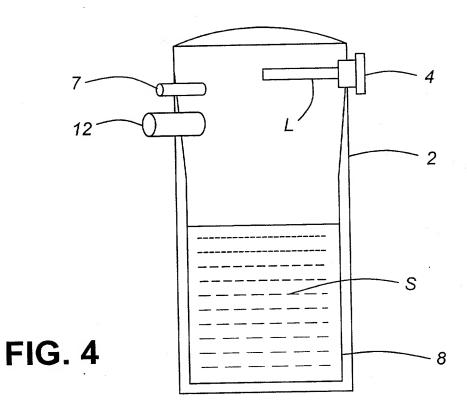


FIG. 2





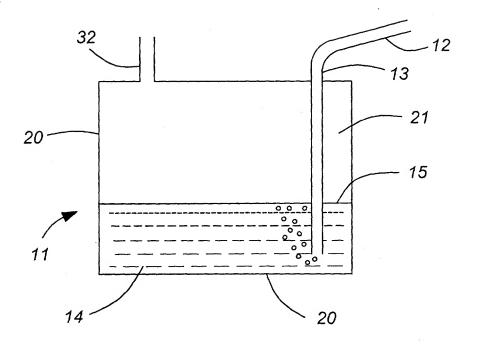
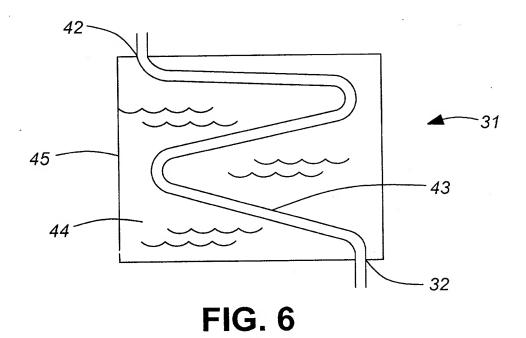


FIG. 5



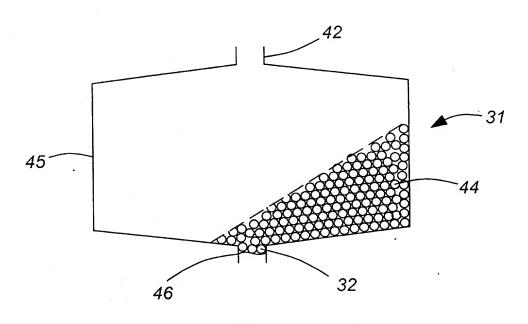
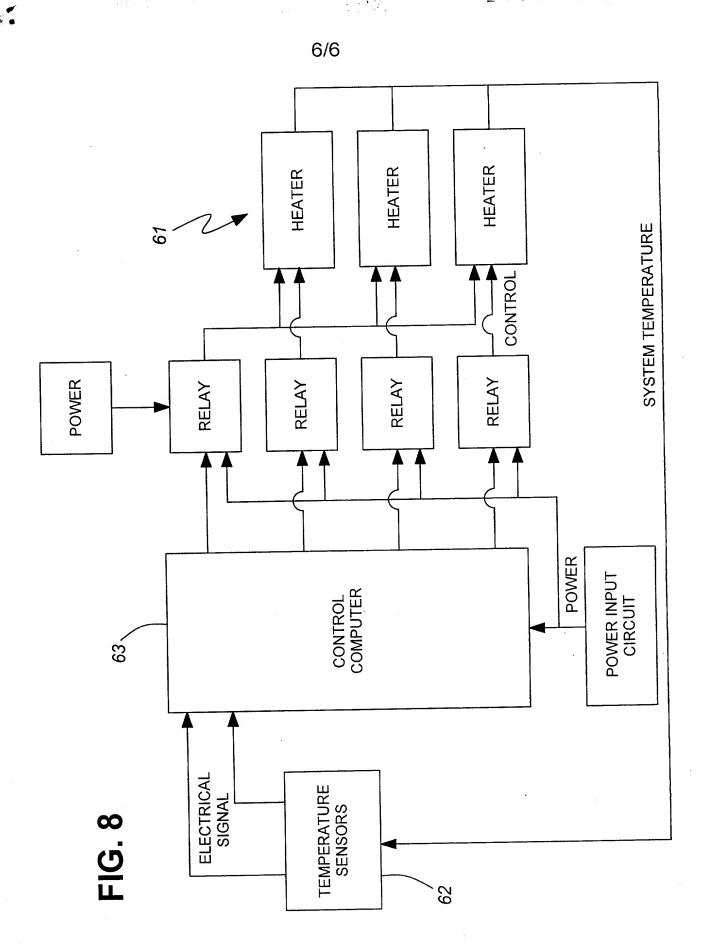


FIG. 7



PTO/SB/01 (03-01)
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**DESIGN** PATENT APPLICATION First Named Inventor

COMPLETE IF KNOWN

Mount, Dennis William

(37 CFR	₹ 1.63)	Application N	lumber						
X Declaration	Declaration Submitted after Initial Filing (surcharge	Filing Date							
Submitted OR with Initial		tial Group Art Uni	it						
Filing	(37 CFR 1.16 (e)) required)	Examiner Na	me						
As a below named inventor, I	As a below named inventor, I hereby declare that:								
My residence, mailing address,	and citizenship are as sta	ted below next to my na	ame.						
I believe I am the original, first a	ind sole inventor (if only or	ne name is listed below	r) or an original, fi	rst and joint invent	or (if plural				
names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:  VAPOUR MANAGEMENT SYSTEM									
	(Title of ti	he Invention)		. awarnana					
the specification of which				•					
is attached hereto		/							
OR  X was filed on (MM/DD/YYYY									
Application Number PCT/CA0	0/00807 and was a	mended on (MM/DD/YY	m		(if applicable).				
I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment specifically referred to above.									
I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.									
I hereby claim foreign priority benefits under 35 U.S.C. 119(a)-(d) or (f), or 365(b) of any foreign application(s) for patent, inventor's or plant breeder's rights certificate(s), or 365(a) of any PCT international application which designated at least one country other than the United States of America, listed below and have also identified below, by checking the box, any foreign application for patent, inventor's or plant breeder's rights certificate(s), or any PCT international application having a filing date before that of the application on which priority is claimed.									
Prior Foreign Application Number(s)	Country	Foreign Filing Date (MM/DD/YYYY)	Priority Not Claimed	Certified Cop YES	y Attached? NO				
2,277,449 PCT/CA00/00807	Canada	07/07/1999 07/07/2000			x x				
Additional foreign application i	Additional foreign application numbers are listed on a supplemental priority data sheet PTO/SB/02B attached hereto:								

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Address 105 East Jefferson Bou	ılev	ard, Suite	400				
City South Bend		jar .	State	Indiana	ZIP 46601		
Country USA	Tele	ephone 219–2	234 <b>-</b> 3	3900	Fax 219-236-2839		
I hereby declare that all statements made herein of are believed to be true; and further that these state made are punishable by fine or imprisonment, or bo validity of the application or any patent issued thereo	tements oth, un	its were made with	h the kno	nowledge that willful fo	false statements and the like co		
NAME OF SOLE OR FIRST INVENTOR:		A petition h	as bee	en filed for this uns	signed inventor		
Given Name (first and middle [if any]) Dennis William	_		Family or Suri	y Name rname Moun	nt		
Inventor's Signature					Date De c 04/01		
Residence: City Ottawa		State Ontai	rial	AX Country Canada	Citizenship Canadian		
14/1 Triole  Mailing Address 331 Cooper Street	e <del>t,</del>	Unit #501					
<b>City</b> Ottawa		Ontario State	0 /	KIB 4T4	Country Canada		
NAME OF SECOND INVENTOR:		A petition has	been	filed for this unsig	gned inventor		
Given Name (first and middle [if any])	i ramiiv name						
Inventor's Signature			_		Date		
Residence: City							
Mailing Address	Mailing Address						
City		State	ZIP		Country		
Additional inventors are being named on the	SUD'	plemental Addition	nal Inver		SB/02A attached hereto.		

PTO/SB/81 (10-00)

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Application Number	100				
Filing Date					
First Named Inventor	Mount, Dennis William				
Group Art Unit					
Examiner Name					
Attorney Docket Number	Chem Champ *1				

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The above-mentioned Customer Number.  OR  X Firm or Individual Name James D. Hall  Address Botkin & Hall LLP  Address 105 East Jefferson Boulevard, Suite 400  City South Bend. State Indiana Zip 46601  Country USA  Telephone 219-234-3900 Fax 219-236-2839  I am the:  X Applicant/Inventor.  Assignee of record of the entire interest. See 37 CFR 3.71.  Statement under 37 CFR 3.73(b) is enclosed. (Form,PTO/SB/96).  SIGNATURE of Applicant or Assignee of Record  Name Dennis William Mount  Signature  Date  NOTE: Signatures of all the inventors or assignees of record of the entire interest or their representative(s) are required. Submit multiple forms if more than one signature is required, see below.	as my/our atto business in th	orney(s) one United	or agent(s) to prosecute the ag States Patent and Trademark	oplication ide	entified above, a lected therewith	and to transact all
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Address Botkin & Hall, LLP  Address 105 East Jefferson Boulevard, Suite 400  City South Bend. State Indiana Zip 46601  Country USA  Telephone 219-234-3900 Fax 219-236-2839  I am the:  X Applicant/Inventor.  Assignee of record of the entire interest. See 37 CFR 3.71.  Statement under 37 CFR 3.73(b) is enclosed. (Form, PTO/SB/96).  SIGNATURE of Applicant or Assignee of Record  Name Dennis William Mount  Signature 1  Date Accord 4 2001  NOTE: Signatures of all the inventors or assignees of record of the entire interest or their representative(s) are required. Submit multiple forms if more than one signature is required, see below.	1 X I	Vame	James D. Hall	•		
Address 105 East Jefferson Boulevard, Suite 400  City South Bend. State Indiana Zip 46601  Country  Telephone 219-234-3900 Fax 219-236-2839  I am the:  X Applicant/Inventor.  Assignee of record of the entire interest. See 37 CFR 3.71.  Statement under 37 CFR 3.73(b) is enclosed. (Form.PTO/SB/96).  SIGNATURE of Applicant or Assignee of Record  Name Dennis William Mount  Signature 1  Date December 4/2001  NOTE: Signatures of all the inventors or assignees of record of the entire interest or their representative(s) are required. Submit multiple forms if more than one signature is required, see below.			Botkin & Hall, LLF	)		· · · · · · · · · · · · · · · · · · ·
Country Telephone 219-234-3900 Fax 219-236-2839  I am the:  X Applicant/Inventor.  Assignee of record of the entire interest. See 37 CFR 3.71.  Statement under 37 CFR 3.73(b) is enclosed. (Form, PTO/SB/96).  SIGNATURE of Applicant or Assignee of Record  Name Dennis William Mount  Signature  Date  Date  Date  NOTE: Signatures of all the inventors or assignees of record of the entire interest or their representative(s) are required. Submit multiple forms if more than one signature is required, see below*.	Address		105 East Jefferson		Jy-Suite 400	)
Telephone 219-234-3900 Fax 219-236-2839  I am the:  X Applicant/Inventor.  Assignee of record of the entire interest. See 37 CFR 3.71.  Statement under 37 CFR 3.73(b) is enclosed. (Form.PTO/SB/96).  SIGNATURE of Applicant or Assignee of Record  Name Dennis William Mount  Signature 1  Date Dac an ba 4/2001  NOTE: Signatures of all the inventors or assignees of record of the entire interest or their representative(s) are required. Submit multiple forms if more than one signature is required, see below*.	City		the state of the s	St	ate Indiana	Zip 46601
I am the:  Applicant/Inventor.  Assignee of record of the entire interest. See 37 CFR 3.71.  Statement under 37 CFR 3.73(b) is enclosed. (Form, PTO/SB/96).  SIGNATURE of Applicant or Assignee of Record  Name  Dennis William Mount  Signature  Date  Date	Country		USA			
Assignee of record of the entire interest. See 37 CFR 3.71.  Statement under 37 CFR 3.73(b) is enclosed. (Form.PTO/SB/96).  SIGNATURE of Applicant or Assignee of Record  Name  Dennis William Mount  Signature  Date  D	Telephone		219-234-3900	Fa	x 219-23	86-2839
Name  Dennis William Mount  Signature  Date  Dace ho 4/2001  NOTE: Signatures of all the inventors or assignees of record of the entire interest or their representative(s) are required. Submit multiple forms if more than one signature is required, see below.	X Applica Assigne	ee of reco	rd of the entire interest. See 3	37 CFR 3.71 (Form,PTO)	SB/96).	
Name  Dennis William Mount  Signature  Date  Dace ho 4/2001  NOTE: Signatures of all the inventors or assignees of record of the entire interest or their representative(s) are required. Submit multiple forms if more than one signature is required, see below.			SIGNATURE of Applicant	or Assignee	of Record	······································
Date  December 4/2001  NOTE: Signatures of all the inventors or assignees of record of the entire interest or their representative(s) are required. Submit multiple forms if more than one signature is required, see below.	Name Dennis William Mount					
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